| Parameter | Rating | Units |
| :--- | :---: | :---: |
| Blocking Voltage | 350 | $V_{P}$ |
| Load Current | 120 | $\mathrm{~mA}_{\text {rms }} / \mathrm{mA}_{D C}$ |
| On-Resistance (max) | 35 | $\Omega$ |
| Input Control Current | 0.25 | mA |

## Features

- Very Low Input Control Current ( 0.25 mA )
- $3750 \mathrm{~V}_{\text {rms }}$ Input/Output Isolation
- Low Drive Power Requirements
- Greater Reliability than Electromechanical Relays
- No EMI/RFI Generation
- Small 6-Pin Package
- Surface Mount, Tape \& Reel Version Available
- Flammability Rating UL 94 V-0


## Applications

- Telecommunications
- Telecom Switching
- Tip/Ring Circuits
- Modem Switching (Laptop, Notebook, PocketSize)
- Hook Switch
- Dial Pulsing
- Ground Start
- Ringing Injection
- Instrumentation
- Multiplexers
- Data Acquisition
- Electronic Switching
- I/O Subsystems
- Meters (Watt-Hour, Water, Gas)
- Medical Equipment Patient/Equipment Isolation
- Industrial Controls


## Description

LCA182 is a normally open (1-Form-A) solid state relay that uses optically coupled MOSFET technology to provide $3750 \mathrm{~V}_{\text {rms }}$ of input to output isolation. It features an extremely low input control current of only 0.25 mA , which is the lowest available in IXYS Integrated Circuits Division's Solid State Relay family.

Its optically coupled outputs, which use the patented OptoMOS architecture, are controlled by a highly efficient infrared LED.

The LCA182 can be used to replace mechanical relays, and offers the superior reliability associated with semiconductor devices. Because it has no moving parts, it offers faster, bounce-free switching in a more compact surface mount or through-hole package.

## Approvals

- UL Recognized Component: File \# E76270
- CSA Certified Component: Certificate \# 1175739
- TUV EN 62368-1: Certificate \# B 0826670008

Ordering Information

| Part \# | Description |
| :--- | :--- |
| LCA182 | 6 Pin DIP (50/Tube) |
| LCA182S | 6 Pin Surface Mount (50/Tube) |
| LCA182STR | 6 Pin Surface Mount (1000/Reel) |

Pin Configuration


Switching Characteristics of Normally Open (Form A) Devices


Absolute Maximum Ratings @ $25^{\circ} \mathrm{C}$

| Parameter | Ratings | Units |
| :--- | :---: | :---: |
| Blocking Voltage | 350 | $\mathrm{~V}_{\mathrm{P}}$ |
| Reverse Input Voltage | 5 | V |
| Input Control Current | 50 | mA |
| Peak (10ms) | 1 | A |
| Input Power Dissipation ${ }^{1}$ | 150 | mW |
| Total Power Dissipation ${ }^{2}$ | 800 | mW |
| Isolation Voltage, Input to Output | 3750 | $\mathrm{~V}_{\text {rms }}$ |
| Operational Temperature, Ambient | -40 to +85 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature | -40 to +125 | ${ }^{\circ} \mathrm{C}$ |

${ }^{1}$ Derate linearly $1.33 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$
2 Derate output power linearly $6.67 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Typical values are characteristic of the device at the specified temperatures and are the result of engineering evaluations. They are provided for information purposes only and are not part of the manufacturing testing requirements.

## Electrical Characteristics @ $25^{\circ} \mathrm{C}$

| Parameter | Conditions | Symbol | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output Characteristics |  |  |  |  |  |  |
| Blocking Voltage | $\mathrm{I}_{\mathrm{L}}=1 \mu \mathrm{~A}$ | $\mathrm{V}_{\text {DRM }}$ | 350 | - | - | $V_{P}$ |
| Load Current Continuous, AC/DC Configuration | ${ }^{-}$ | $\mathrm{I}_{\mathrm{L}}$ | - | - | 120 | $\mathrm{mA}_{\text {rms }} / \mathrm{mA}$ DC |
| Continuous, DC Configuration |  |  |  |  | 200 | $\mathrm{mA}_{\mathrm{DC}}$ |
| Peak | $\mathrm{t}=10 \mathrm{~ms}$ | $\mathrm{I}_{\text {LPK }}$ | - | - | 350 | mA |
| On-Resistance ${ }^{1}$ |  |  |  |  |  |  |
| AC/DC Configuration | $\mathrm{I}_{\mathrm{L}}=120 \mathrm{~mA}$ | $\mathrm{R}_{\mathrm{ON}}$ | - | 23 | 35 | $\Omega$ |
| DC Configuration | $\mathrm{I}_{\mathrm{L}}=200 \mathrm{~mA}$ |  |  | 7 | 10 |  |
| Off-State Leakage Current | $\mathrm{V}_{\mathrm{L}}=350 \mathrm{~V}_{\mathrm{P}}$ | $\mathrm{I}_{\text {LEAK }}$ | - | - | 1 | $\mu \mathrm{A}$ |
| Switching Speeds |  |  |  |  |  |  |
| Turn-On | $\mathrm{I}_{\mathrm{F}}=1 \mathrm{~mA}, \mathrm{~V}_{\mathrm{L}}=10 \mathrm{~V}$ | $\mathrm{t}_{\text {on }}$ | - | - | 3 | ms |
| Turn-Off |  | $\mathrm{t}_{\text {off }}$ |  | - | 3 |  |
| Output Capacitance | $\mathrm{I}_{\mathrm{F}}=0 \mathrm{~mA}, \mathrm{~V}_{\mathrm{L}}=50 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ | $\mathrm{C}_{\text {OUT }}$ | - | 25 | - | pF |
| Input Characteristics |  |  |  |  |  |  |
| Input Control Current to Activate ${ }^{2}$ | $\mathrm{I}_{\mathrm{L}}=120 \mathrm{~mA}$ | $I_{F}$ | - | - | 0.25 | mA |
| Input Control Current to Deactivate | - | $\mathrm{I}_{\mathrm{F}}$ | 0.05 | - | - | mA |
| Input Voltage Drop | $\mathrm{I}_{\mathrm{F}}=1 \mathrm{~mA}$ | $V_{F}$ | 0.9 | 1.2 | 1.4 | V |
| Reverse Input Current | $\mathrm{V}_{\mathrm{R}}=5 \mathrm{~V}$ | $I_{\text {R }}$ | - | - | 10 | $\mu \mathrm{A}$ |
| Common Characteristics |  |  |  |  |  |  |
| Input to Output Capacitance | $\mathrm{V}_{10}=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ | $\mathrm{C}_{10}$ | - | 3 | - | pF |

${ }^{1}$ Measurement taken within one second of on-time.
${ }^{2}$ It is recommended that the input control current be increased to 1 mA in high temperature ( $>55^{\circ} \mathrm{C}$ ) operation.

## PERFORMANCE DATA*




Typical $I_{F}$ for Switch Dropout ( $\mathrm{N}=50, \mathrm{I}_{\mathrm{L}}=120 \mathrm{~mA}_{\mathrm{DC}}$ )


Typical Blocking Voltage Distribution ( $\mathrm{N}=50$ )


Typical Turn-On Time vs. LED Forward Current



Typical Turn-On Time

Typical On-Resistance Distribution



Typical Turn-Off Time

Typical LED Forward Voltage Drop
vs. Temperature

*Unless otherwise noted, data presented in these graphs is typical of device operation at $25^{\circ} \mathrm{C}$.

PERFORMANCE DATA*


## Manufacturing Information

Moisture Sensitivity


All plastic encapsulated semiconductor packages are susceptible to moisture ingression. IXYS Integrated Circuits classifies its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, IPC/JEDEC J-STD-020, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a Moisture Sensitivity Level (MSL) classification as shown below, and should be handled according to the requirements of the latest version of the joint industry standard IPC/JEDEC J-STD-033.

| Device | Moisture Sensitivity Level (MSL) Classification |
| :---: | :---: |
| LCA182S | MSL 1 |

## ESD Sensitivity



This product is ESD Sensitive, and should be handled according to the industry standard JESD-625.

## Soldering Profile

Provided in the table below is the IPC/JEDEC J-STD-020 Classification Temperature ( $\mathrm{T}_{\mathrm{C}}$ ) and the maximum total dwell time ( $\mathrm{t}_{\mathrm{p}}$ ) in all reflow processes that the body temperature of these surface mount devices may be ( $\left.\mathrm{T}_{\mathrm{C}}-5\right)^{\circ} \mathrm{C}$ or greater. The device's body temperature must not exceed the Classification Temperature at any time during reflow soldering processes.

| Device | Classification Temperature ( $T_{\mathrm{c}}$ ) | Dwell Time $\left(\mathrm{t}_{\mathrm{p}}\right)$ | Max Refilow Cycles |
| :---: | :---: | :---: | :---: |
| LCA182S | $250^{\circ} \mathrm{C}$ | 30 seconds | 3 |

For through-hole devices, the maximum pin temperature and maximum dwell time through all solder waves is provided in the table below. Dwell time is the interval beginning when the pins are initially immersed into the solder wave until they exit the solder wave. For multiple waves, the dwell time is from entering the first wave until exiting the last wave. During this time, pin temperatures must not exceed the maximum temperature given in the table below. Body temperature of the device must not exceed the limit shown in the table below at any time during the soldering process.

| Device | Maximum Pin Temperature | Maximum Body Temperature | Maximum Dwell Time | Wave Cycles |
| :---: | :---: | :---: | :---: | :---: |
| LCA182 | $260^{\circ} \mathrm{C}$ | $250^{\circ} \mathrm{C}$ | 10 seconds | 1 |

> *Total cumulative duration of all waves.

## Board Wash

IXYS Integrated Circuits recommends the use of no-clean flux formulations. Board washing to reduce or remove flux residue following the solder reflow process is acceptable provided proper precautions are taken to prevent damage to the device. These precautions include but are not limited to: using a low pressure wash and providing a follow up bake cycle sufficient to remove any moisture trapped within the device due to the washing process. Due to the variability of the wash parameters used to clean the board, determination of the bake temperature and duration necessary to remove the moisture trapped within the package is the responsibility of the user (assembler). Cleaning or drying methods that employ ultrasonic energy may damage the device and should not be used. Additionally, the device must not be exposed to halide flux or solvents.
e3

## MECHANICAL DIMENSIONS

## LCA182




Controlling dimension: inches
$\frac{\text { Dimensions }}{\mathrm{mm}}$

## LCA182S



PCB Land Pattern


Controlling dimension: inches
$\frac{\text { Dimensions }}{\mathrm{mm}}$ $\frac{\mathrm{mm}}{\text { (inches) }}$

## LCA182STR Tape \& Reel



1. All dimensions carry tolerances of EIA Standard 481-2
2. The tape complies with all "Notes" for constant dimensions listed on page 5 of EIA-481-2

For additional information please visit our website at: https://www.ixysic.com

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